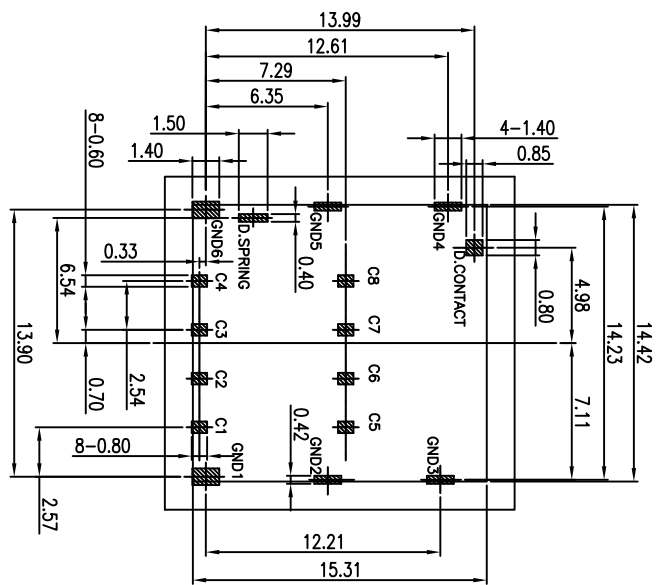
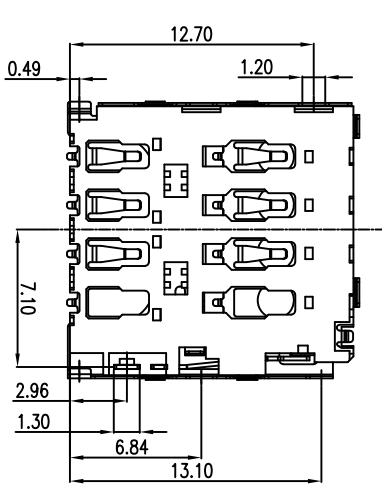
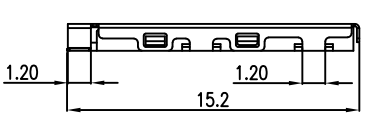
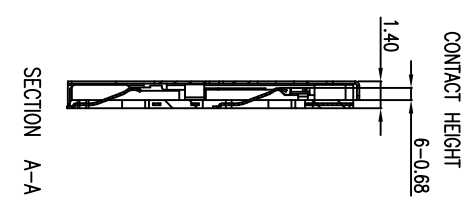
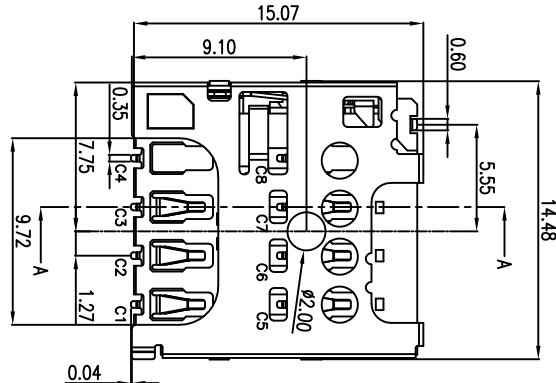


ROHS

| REV. | EC# | DESCRIPTION | DATE | DRAWING | CHECKED | APPROVED |
|------|-----|-------------|----------|---------|---------|----------|
| A0 | | NEW RELEASE | 04/25'19 | HFL | HFL | WZX |



CIRCUIT DIAGRAM FOR DETECT SWITCH

| CARD INSERTION STATE | DETECT SWITCH CIRCUIT STATE | SCHEMATIC |
|----------------------|-----------------------------|------------|
| CARD MATED | OPENED | D.S. D.C. |
| CARD UNMATED | CLOSED | D.S. D.C. |

| |
|---------------------|
| D.S. DETECT SPRING |
| D.C. DETECT CONTACT |

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

| ITEM | NAME | QTY | DESCRIPTION | NOTE |
|------|------------|-----|---|------|
| 4 | Solder pad | 1 | SUS 304,Nickel 10u" Min under plating overall,TIN (30u" MIN.) Plating on solder area | |
| 3 | Shell | 1 | SUS 304,Nickel 30u" Min Under plating | |
| 2 | Terminal | 1 | C5210, Nickel 30u" Min Under plating Overall, gold 0.8u" Min Plating on contact area.Gold | |
| 1 | Housing | 1 | 0.8u" Min Plating On solder Area; LCP +30%GF UL94V-0 Black | |

| MILLIMETERS | INCH | UNITS |
|-------------|-------------|-----------|
| X° ± Z' | X° ± Z' | MM |
| X ±0.30 | XX ±0.012 | MATL |
| XX ±0.20 | XXX ±0.008 | SEE NOTES |
| .XXX±0.10 | .XXXX±0.004 | FINISH |
| | | SEE NOTES |
| | | QTY |
| | | SEE NOTES |

MINITRON TECHNOLOGY CO.,LTD.

PART NUMBER: MT102312892
TITLE: Micro Sim H1.4 6P 客户图

APPD: DWG NO.: C-102312892-00
CHKD: DR: SCALE: 1:1 SHEET: 1/2 REV: A0